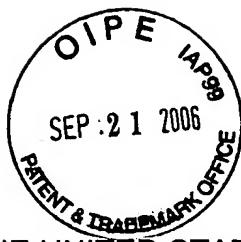


P29770.A02



IFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Junko KAKEGAWA

Confirmation No. : 8831

Appl. No. : 10/576,259
(National Stage of PCT/JP2004/016008)

Group Art Unit : Not Yet Assigned

Examiner : Not Yet Assigned

I.A. Filed : October 28, 2004

For : POLYTRIMETHYLENE TEREPHTHALATE REINFORCED
RESIN COMPOSITION

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop AMENDMENT
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In accordance with the duty of disclosure under 37 C.F.R. §1.56 and §§1.97-1.98,
Applicant hereby brings to the attention of the Examiner the following documents cited in
the International Search Report of International Patent Application No.
PCT/JP2004/016008, of which the present application is the U.S. National Stage:

- (1) JP 2003-119363 A, April 23, 2003, together with an English language
Abstract thereof (obtained from esp@cenet);
- (2) JP 2003-119365 A, April 23, 2003, together with an English language
Abstract thereof (obtained from esp@cenet);

- (3) JP 5-209117 A, August 20, 1993, together with an English language Abstract thereof (obtained from esp@cenet), Applicant also notes that this document also cited on page 3 of the specification of the present application.
- (4) U.S. Patent No. 5,300,546 (NELSON et al.), April 5, 1994; Applicants note that this document is a family member of document (3);
- (5) JP 7-113037 A, May 2, 1995, together with an English language Abstract thereof (obtained from esp@cenet);
- (6) JP 2003-20389 A, January 24, 2003, together with an English language Abstract thereof (obtained from esp@cenet).

Applicant further submits the following documents cited and discussed in the present application:

- (7) JP 6-212065 A, August 2, 1994, together with an English language Abstract thereof (obtained from esp@cenet); Applicant notes that this document is cited at page 3 of the specification of the above-captioned application.
- (8) JP 2002-129027 A, May 9, 2002, together with an English language thereof (obtained from esp@cenet); Applicant notes that this document is cited at page 3 of the specification of the present application.
- (9) JP 47-3444 A, February 19, 1972, together with an English language translation of the claims thereo; Applicant notes that this document is cited at page 4 of the specification of the present application.

- (10) WO 02/090435 A1, November 14, 2002; Applicant notes that this document is cited at page 4 of the specification of the present application;
- (11) U.S. Patent Application Publication No. 2004/0147635 A1 (MAEKAWA), July 29, 2004; Applicant notes that this document is a family member of document (10);
- (12) JP 51-140992, December 4, 1976, together with an English language Abstract thereof (obtained from esp@cenet); Applicant notes that this document is cited at page 12 of the present application;
- (13) JP 5-262862 A, October 12, 1993; Applicant notes that this document is cited at page 12 of the present application;
- (14) U.S. Patent No. 5,340,909 (DOERR et al.), August 23, 1994; Applicant notes that this document is a family member of document (13);
- (15) JP 8-311177 A, November 26, 1996, together with an English language Abstract thereof (obtained from esp@cenet); Applicant notes that this document is cited at page 12 of the present application.

Applicant further directs the Examiner's attention to the following co-pending, commonly assigned application:

- (16) U.S. Application No. 10/582,556 to MAEKAWA, filed June 9, 2006 and entitled "THERMOPLASTIC RESIN COMPOSITION"; Applicant notes that

this document is a national stage of PCT/JP2004/018388, which has published as WO2005/056677 A1, June 23, 2005.

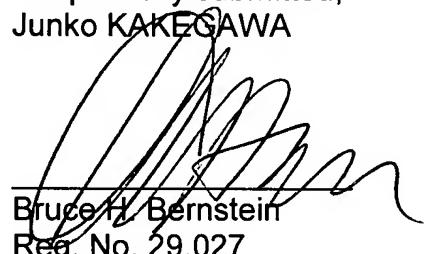
Copies of the above-listed documents (with the exception of the U.S. patents and U.S. patent applications) and the International Search Report for International Application PCT/JP 2004/016008 (in English and Japanese) are enclosed together with a completed copy of the PTO-1449 Form listing these documents. Accordingly, the Examiner is requested to consider these documents and to indicate such consideration by returning a signed and initialed copy of the PTO-1449 Form with the next official communication.

Further to 37 C.F.R. § 1.98 (a)(2)(ii) and to the U.S. Patent and Trademark Office's decision to waive the requirement under 37 C.F.R. §1.98 (a)(2)(iii) for U.S. patent applications filed after June 30, 2003, copies of the above-listed U.S. patents and U.S. patent applications are not enclosed herewith. However, if a copy is needed, the Examiner is respectfully requested to contact the undersigned.

Applicants note that an Office Action on the merits has not yet issued in the instant application, and thus, no fee is necessary to ensure consideration of this statement. However, if an Office Action has issued and is crossing in the mail with this statement, the Patent and Trademark Office is hereby authorized to charge Deposit Account No. 19-0089 any fee necessary to ensure consideration of the submitted materials.

Should the Examiner have any questions, the Examiner is invited to contact the undersigned at the below-listed telephone number.

Respectfully submitted,
Junko KAKEGAWA


Bruce H. Bernstein
Reg. No. 29,027

September 14, 2006
GREENBLUM & BERNSTEIN, P.L.C.
1950 Roland Clarke Place
Reston, Virginia 20191
(703) 716-1191

Arnold Turk
Reg. No. 33094

FORM PTO-1449

SEP 21 2006 U.S. Department of Commerce
Patent and Trademark OfficeAtty. Docket No.
P29770Application No.
10/576,259INFORMATION DISCLOSURE STATEMENT
BY APPLICANT
(Use several sheets if necessary)Applicant
Junko KAKEGAWAFiling Date
October 28, 2004Group
Unknown

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
		5 3 0 0 5 4 6	04/05/94	NELSON et al.			
2004		0 1 4 7 6 3 5	07/29/04	MAEKAWA			
		5 3 4 0 9 0 9	08/23/94	DOERR et al.			

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO
	2003	- 1 1 9 3 6 3	04/23/03	JAPAN			
	2003	- 1 1 9 3 6 5	04/23/03	JAPAN			
	5	- 2 0 9 1 1 7	08/20/93	JAPAN			
	7	- 1 1 3 0 3 7	05/02/95	JAPAN			
	2003	- 2 0 3 8 9	01/24/03	JAPAN			
	6	- 2 1 2 0 6 5	08/02/94	JAPAN			
	2002	- 1 2 9 0 2 7	05/09/02	JAPAN			
	47	- 3 4 4 4	02/19/72	JAPAN			X
	02	/ 0 9 0 4 3 5	11/14/02	W.I.P.O			
	51	- 1 4 0 9 9 2	12/04/76	JAPAN			
	5	- 2 6 2 8 6 2	10/12/93	JAPAN			
	8	- 3 1 1 1 7 7	11/26/96	JAPAN			
	2005	/ 0 5 6 6 7 7	06/23/05	W.I.P.O			

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

1	English language Abstract of JP 2003-119363.
2	English language Abstract of JP 2003-119365.
3	English language Abstract of JP 5-209117.
4	English language Abstract of JP 7-113037.
5	English language Abstract of JP 2003-20389.
6	English language Abstract of JP 6-212065.
7	English language Abstract of JP 2002-129027.
8	English language Abstract of JP 51-140992.
9	English language Abstract of JP 8-311117.
10	U.S. Application No. 10/582,556 to MAEKAWA, filed 06/09/06

EXAMINER

DATE CONSIDERED

*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.